Heavy-operational and equipped with a 1.4mm tall stem and grounding, meeting in-car needs





Typical Specifications		
Items	Specifications	
Rating (max.)	50mA 12V DC	
Rating (min.)	10µA 1V DC	
Initial contact resistance	100mΩ max.	
Travel (mm)	0.12	

Product Line

Top push type

Product No.	O	Operating direction	Operating life	01	Minimum order unit (pcs.)	
FIOUUCTINO.	Operating force		(5mA 5V DC)	Stem color	Japan	Export
SKSGACE010	1.6N	. Top push	200,000 cycles -	Natural	12,000	12,000
SKSGAAE010	4N	TOP PUSIT		Black		

With ground terminal type

Product No.	Operating force	Operating direction	Operating life	Stem color	Minimum ord	er unit (pcs.)
	Operating force		(5mA 5V DC)		Japan	Export
SKSGPCE010	1.6N	Top puch	200.000 cvcles	Natural	12.000	12.000
SKSGPAE010	4N	i op pusit	Top push 200,000 cycles	Black	12,000	12,000

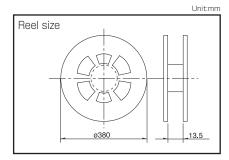
Packing Specifications

Taping

Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
12,000	120,000	120,000	12	401×401×214

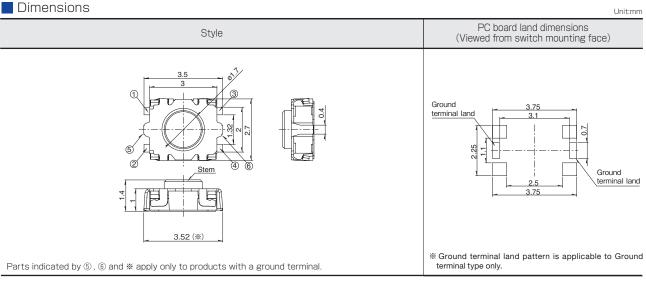
Note

For reels of 330mm diameter, please inquire.

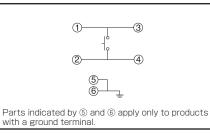




SKSG 3 × 2.7mm Compact High Operating Force (Surface Mount Type)



Circuit Diagram





	Туре				Sharp Fee Surface				
	Series	SKSD	SKRN	SKSV	SKSW	SKSF	SKSM	SKSG	SKRK
	Photo	and the second	\diamond			٢	\bigcirc		
	Features	Double	e action		Compac Low-p			High operation force Compact size	Compact siz Low-profile
	Water-proof		_	•	•	_	•	_	
	Dust-proof			•	•	_	•	_	
	IP standard	_	_	67 equivalency	67 equivalency	_	_	_	
Operatir	Top push	•	•	•	•	٠	•	•	•
directio		_		_	_	_	_	_	
	W	4.1		2.8	3	2.8	3.4	3	3.9
Dimensio (mm)	ons D	3.9	□6	1.9	2	2.4	2.9	2.7	2.9
(11111)	Н	0.6	0.9	0.55	0.6	0.65	0.7	1.4	1.5/2
Operatio force coverag	2N to 3N	for respect	evant pages ive product iptions	1	ŧ	\$	\$	Ţ	Ţ
	Travel (mm)		ant pages for uct descriptions	0.12	0.13	(D.1	0.12	0.13
G	round terminal	•	•	_	_	_	_	0	_
Operatin	ig temperature range	-40°C to +90°C -30°C to +85°C -40°C				—40℃ to +85			
A	utomotive use	_	_	_	_	_	_	•	—
	Life Cycle	* 2	2	2	2				
	Rating (max.) (Resistive load)				50mA 1	2V DC			
Electrical	Rating (min.) (Resistive load)				10µA	IV DC			
performance	Insulation resistance		100M	Ω min. 100V D	C 1min.		50MΩ min. 100V DC 1min.	100MΩ min. 1	00V DC 1min
	Voltage proof	100V AC 1min.	250V AC 1min.		1	OOV AC 1mi	n.		250V AC 1m
Durability	Vibration		10 to	55 to 10Hz/m in the 3 direc	nin., the amplitud ction of X, Y and	de is 1.5mm f d Z for 2 hour	or all the freque	encies,	
Durability	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40℃ 96h							
nvironmental performance	Dry heat	90°C 96h							
	Damp heat	60°C, 90 to 95%RH 96h					1		
	Page	217	218	219	220	221	222	223	225
	itch [™] Soldering Con				D : [H : F	Depth. The m	ost outer dimens ost outer dimens inimum dimensi	sion excluding t	erminal portio ariances.

1. The automotive operating temperature range to be individually discussed upon request.

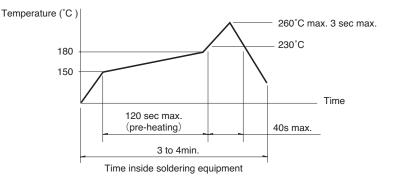
2. Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.



Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface) A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- 1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 $\ensuremath{\mathbb{C}}$ max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT Switch[™].

- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)

Manual Soldering

	<u> </u>
Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	20W max.

